

## STP62NS04Z

# N-channel clamped 12.5 mΩ, 62 A, TO-220 fully protected MESH OVERLAY™ Power MOSFET

#### **Features**

Туре	V <sub>DSS</sub>	R <sub>DS(on)</sub> max	I <sub>D</sub>
STP62NS04Z	Clamped	< 0.015 Ω	62 A

- 100% avalanche tested
- Low capacitance and gate charge
- 175 °C maximum junction temperature

## **Application**

■ Switching applications

#### **Description**

Fully clamped MOSFET is produced by using ST's most advanced MESH OVERLAY™ process based on strip layout. The inherent benefits of this new technology coupled with the extra clamping capabilities make this product particularly suitable for the harshest operating conditions such as those encountered in the automotive environment. It is also recommended for any other application requiring extra ruggedness.

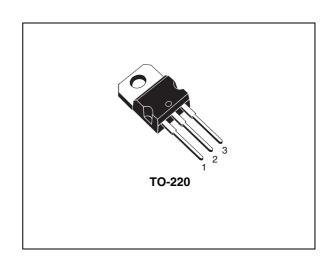


Figure 1. Internal schematic diagram

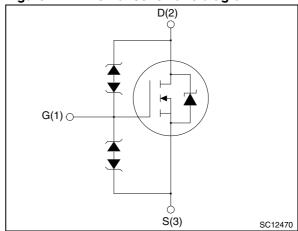


Table 1. Device summary

Order code	Marking	Package	Packaging	
STP62NS04Z	P62NS04Z	TO-220	Tube	

Contents STP62NS04Z

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STP62NS04Z Electrical ratings

# 1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V <sub>DS</sub>	Drain-source voltage (V <sub>GS</sub> = 0)	Clamped	V
V <sub>GS</sub>	Gate-source voltage	Clamped	V
I <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> = 25 °C	62	Α
I <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> =100 °C	37.5	Α
I <sub>DG</sub>	Drain gate current (continuous)	± 50	mA
I <sub>GS</sub>	Gate sourcecurrent (continuous)	± 50	mA
I <sub>DM</sub> <sup>(1)</sup>	Drain current (pulsed)	248	Α
P <sub>TOT</sub>	Total dissipation at T <sub>C</sub> = 25 °C	110	W
	Derating factor	0.74	W/°C
dv/dt (2)	Peak diode recovery voltage slope	8	V/ns
E <sub>AS</sub> (3)	Single pulse avalanche energy	500	mJ
V <sub>ESD</sub>	ESD (HBM - C = 100 pF, R = 1.5 kΩ)	8	V
T <sub>J</sub> T <sub>stg</sub>	Operating junction temperature Storage temperature	-55 to 175	°C

<sup>1.</sup> Pulse width limited by safe operating area

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R <sub>thj-c</sub>	Thermal resistance junction-casemax	1.36	°C/W
R <sub>thj-a</sub>	Thermal resistance junction-ambient max	62.5	°C/W
T <sub>I</sub>	Maximum lead temperature for soldering purpose	300	°C

<sup>2.</sup>  $I_{SD} \leq$  40 A, di/dt  $\leq$  100 A/µs,  $V_{DD} \leq$   $V_{(BR)DSS}$ ,  $T_{j} \leq$   $T_{JMAX}$ 

<sup>3.</sup> Starting  $T_J = 25$  °C,  $I_D = 20$  A,  $V_{DD} = 20$  V

Electrical characteristics STP62NS04Z

## 2 Electrical characteristics

(T<sub>CASE</sub>=25 °C unless otherwise specified)

Table 4. On/off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage	I <sub>D</sub> = 1 mA, V <sub>GS</sub> = 0	33			V
I <sub>DSS</sub>	Zero gate voltage drain current (V <sub>GS</sub> = 0)	V <sub>DS</sub> = 16 V			10	μΑ
I <sub>GSS</sub>	Gate body leakage current (V <sub>DS</sub> = 0)	V <sub>GS</sub> = ±10 V			10	μΑ
V <sub>GSS</sub>	Gate-source breakdown voltage	I <sub>GS</sub> = 100 μA	18			٧
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2		4	V
R <sub>DS(on)</sub>	Static drain-source on resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 30 A		12.5	15	mΩ

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
9 <sub>fs</sub> (1)	Forward transconductance	$V_{DS} = 15 \text{ V}, I_{D} = 30 \text{ A}$	-	20		S
C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub>	Input capacitance Output capacitance Reverse transfer capacitance	V <sub>DS</sub> =25 V, f = 1 MHz, V <sub>GS</sub> = 0	-	1330 420 135		pF pF pF
Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub>	Total gate charge Gate-source charge Gate-drain charge	V <sub>DD</sub> = 20 V, I <sub>D</sub> = 40 A V <sub>GS</sub> =10 V	-	34 10 11.5	47	nC nC nC

<sup>1.</sup> Pulsed: pulse duration=300µs, duty cycle 1.5%

Table 6. Switching times

Symbo	I Parameter	Test conditions	Min.	Тур.	Max.	Unit
$\begin{array}{c} t_{d(on)} \\ t_{r} \\ t_{d(off)} \\ t_{f} \end{array}$	Turn-on delay time Rise time Turn-off delay time Fall time	$V_{DD}$ = 20 V, $I_{D}$ = 20 A, $R_{G}$ =4.7 $\Omega$ , $V_{GS}$ = 10 V Figure 14 on page 8	-	13 104 41 42	-	ns ns ns ns
t <sub>r(Voff)</sub> t <sub>f</sub> t <sub>C</sub>	Off-voltage rise time Fall time Cross-over time	$V_{clamp}$ = 30 V, $I_D$ = 40 A R <sub>G</sub> = 4.7 $\Omega$ , $V_{GS}$ = 10 V Figure 14 on page 8	-	30 54 90	-	ns ns ns

Table 7. Source drain diode

Symbol	Parameter	Test conditions	Min	Тур.	Max	Unit
I <sub>SD</sub>	Source-drain current		-		62	Α
I <sub>SDM</sub> <sup>(1)</sup>	Source-drain current (pulsed)		-		248	Α
V <sub>SD</sub> <sup>(2)</sup>	Forward on voltage	$I_{SD} = 62 \text{ A}, V_{GS} = 0$	-		1.5	V
t <sub>rr</sub> Q <sub>rr</sub> I <sub>RRM</sub>	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_{SD}$ = 40 A, di/dt = 100 A/µs, $V_{DD}$ = 20 V, $T_{J}$ = 150 °C Figure 16 on page 8	-	45 65 2.9		ns nC A

<sup>1.</sup> Pulse width limited by safe operating area

<sup>2.</sup> Pulsed: pulse duration=300µs, duty cycle 1.5%

Electrical characteristics STP62NS04Z

#### 2.1 Electrical characteristics (curves)

Figure 2. Safe operating area

Figure 3. Thermal impedance

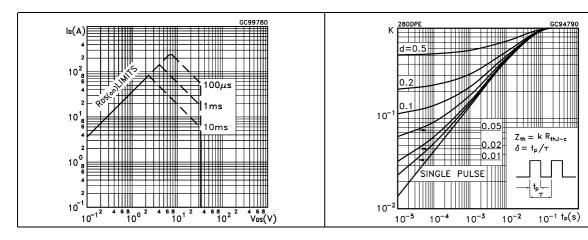


Figure 4. Output characterisics

Figure 5. Transfer characteristics

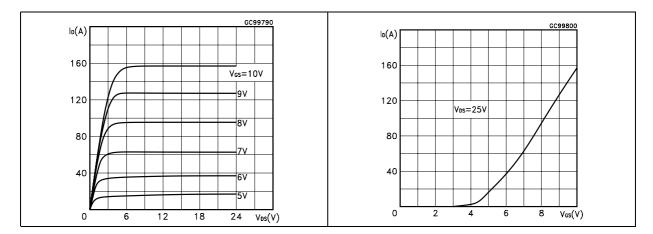


Figure 6. Transconductance

Figure 7. Static drain-source on resistance

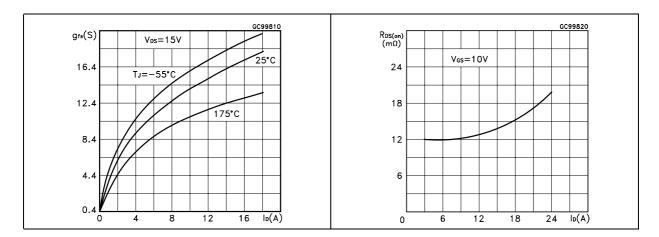


Figure 8. Gate charge vs gate-source voltage Figure 9. Capacitance variations

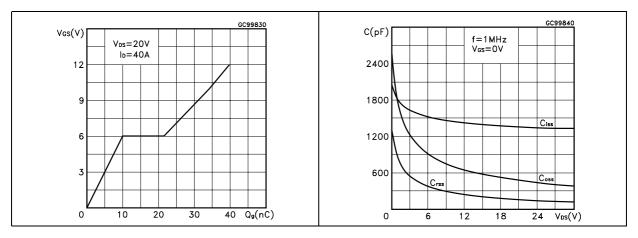


Figure 10. Normalized gate threshold voltage Figure 11. Normalized on resistance vs vs temperature temperature

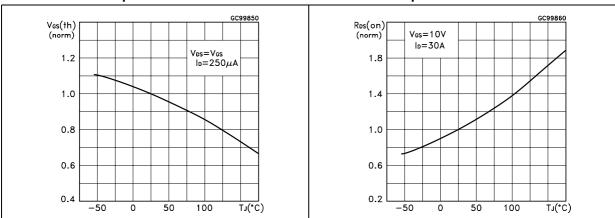
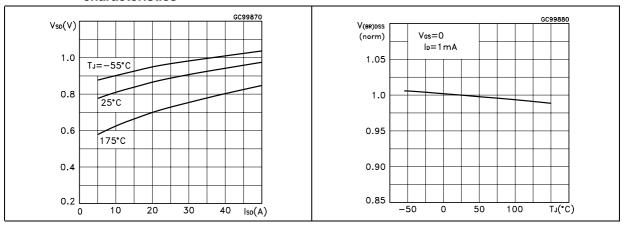


Figure 12. Source-drain diode forward characteristics

Figure 13. Normalized  $B_{VDSS}$  vs temperature



Test circuits STP62NS04Z

#### 3 Test circuits

Figure 14. Switching times test circuit for resistive load

Figure 15. Gate charge test circuit

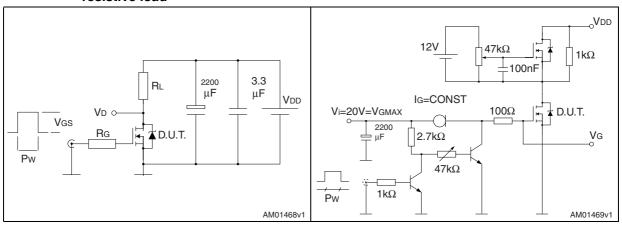


Figure 16. Test circuit for inductive load switching and diode recovery times

Figure 17. Unclamped inductive load test circuit

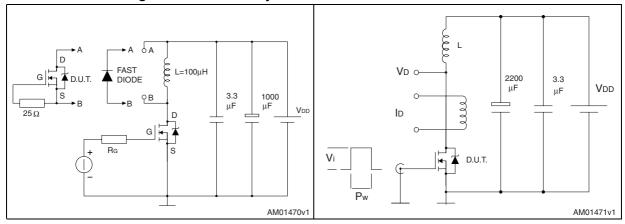
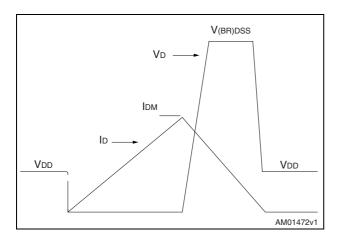


Figure 18. Unclamped inductive waveform

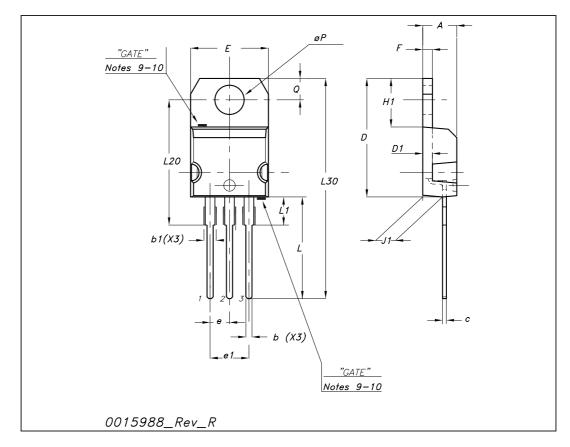


# 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

#### TO-220 mechanical data

Dim		mm			inch	
Dim	Min	Тур	Max	Min	Тур	Max
Α	4.40		4.60	0.173		0.181
b	0.61		0.88	0.024		0.034
b1	1.14		1.70	0.044		0.066
С	0.48		0.70	0.019		0.027
D	15.25		15.75	0.6		0.62
D1		1.27			0.050	
E	10		10.40	0.393		0.409
е	2.40		2.70	0.094		0.106
e1	4.95		5.15	0.194		0.202
F	1.23		1.32	0.048		0.051
H1	6.20		6.60	0.244		0.256
J1	2.40		2.72	0.094		0.107
L	13		14	0.511		0.551
L1	3.50		3.93	0.137		0.154
L20		16.40			0.645	
L30		28.90			1.137	
ØP	3.75		3.85	0.147		0.151
Q	2.65		2.95	0.104		0.116



STP62NS04Z Revision history

# 5 Revision history

Table 8. Document revision history

Date	Revision	Changes
21-Jun-2004	2	Preliminary datasheet
22-Aug-2005	3	Complete document with curves
21-Jan-2006	4	New ECOPAK label
02-Oct-2006	5	New template, no content change
14-May-2009	6	Updated scheme in Figure 1

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